

Light is OSRAM

05/04/2015

OS-IN-2015-014

Introduction of new die attach glue for Chipled products

Objective	Introduction of new die attach glue for Chipled products
Products affected	SFH 4059SR SFH 4059S SFH 4043
Application	Chipled
Background	Continuous product improvement
Realization	Introduction of new die attach glue resulting in better matching of coefficient of thermal expansion of glue towards chip and towards PCB.
Time Schedule	Earliest shipment of new devices from CW24 / 2015 onwards
Assessment	No change in product data sheet

Please direct your inquiry to your local Sales office.

Products Affected by Information Notification

Number: OS-IN-2015-014

Name: Introduction of new die attach glue for Chiplad products

Release Date: 5/4/2015

Implementation Date: 6/13/2015

<i>Product</i>	<i>QNumber</i>	<i>QNumber Description</i>	<i>Part Number</i>
SFH 4043	Q65111A3691	SFH 4043	SFH 4043
SFH 4059S	Q65111A2990	SFH 4059S	SFH 4059S
	Q65111A5306	SFH 4059S-RS	SFH 4059S-RS
SFH 4059SR	Q65111A5310	SFH 4059SR	SFH 4059SR